

Notice of References Cited

Application/Control No.	Applicant(s)/Pater	nt Under	
09/938,435	Reexamination WON ET AL.		
Examiner	Art Unit		
Christopher G. Paulraj	1773	Page 1 of 1	

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NON-PATENT DOCUMENTS

*		Include as applicable: Author, Title Date, Publisher, Edition or Volume, Pertinent Pages)
	U	Ekbundit et al., Characterization of film uniformity in LPCVD TEOS Vertical Furnace, 2002 IEEE/SEMI Advanced Semiconductor Manufacturing Conference, pp 38-42
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*A copy of this reference is not being furnished with this Office action. (See MPEP § 707.05(a).) Dates in MM-YYYY format are publication dates. Classifications may be US or foreign.